ON Semiconductor

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N-Channel Power MOSFET 100 V, 77 A, 14 m Ω

Features

- Low R_{DS(on)}
- High Current Capability
- 100% Avalanche Tested
- NVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25° C Unless otherwise specified)

Para	Symbol	Value	Unit		
Drain-to-Source Voltage			V _{DSS}	100	V
Gate-to-Source Voltage - Continuous			V _{GS}	±20	V
Continuous Drain	Steady State	$T_{C} = 25^{\circ}C$	I _D	77	А
Current $R_{\theta JC}$		$T_{C} = 100^{\circ}C$		54	
Power Dissipation $R_{\theta JC}$	Steady State	T _C = 25°C	P _D	217	W
Pulsed Drain Current	tp	= 10 μs	I _{DM}	285	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			I _S	77	А
Single Pulse Drain-to-Source Avalanche Energy (V _{DD} = 50 Vdc, V _{GS} = 10 Vdc, I _{L(pk)} = 56 A, L = 0.3 mH, R _G = 25 Ω)			E _{AS}	470	mJ
Lead Temperature for Soldering Purposes, 1/8" from Case for 10 Seconds			ΤL	260	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Case (Drain) Steady State	$R_{\theta JC}$	0.69	°C/W
Junction-to-Ambient (Note 1)	$R_{\theta JA}$	33	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

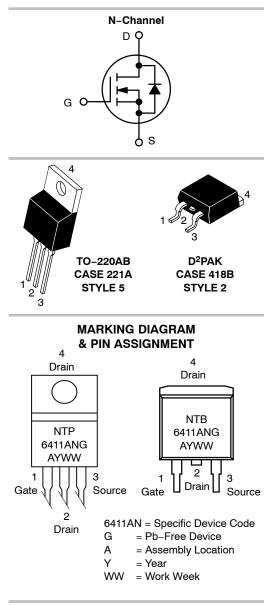
1. Surface mounted on FR4 board using 1 sq in pad size, (Cu Area 1.127 sq in [2 oz] including traces).



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX (Note 1)
100 V	14 m Ω @ 10 V	77 A

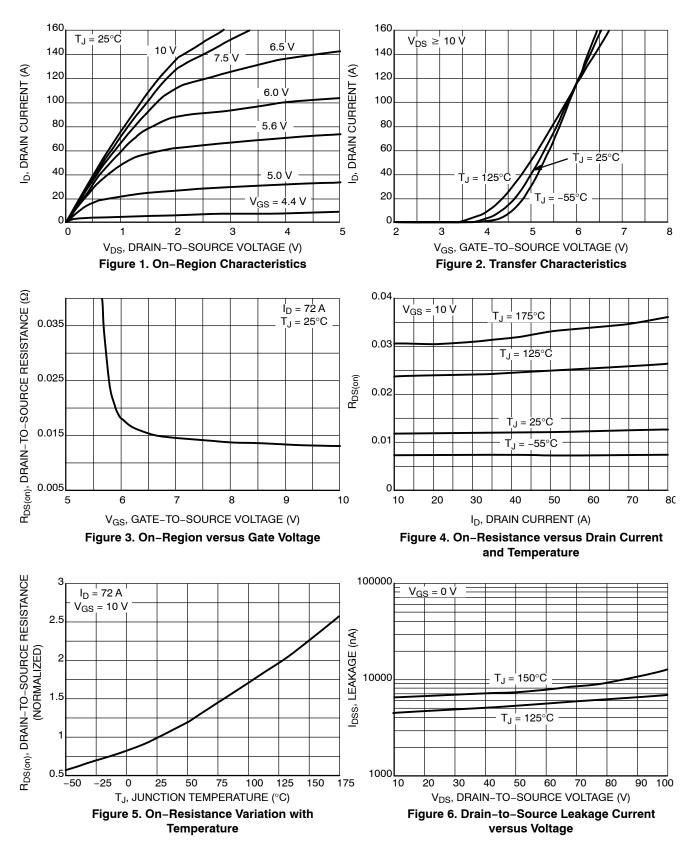


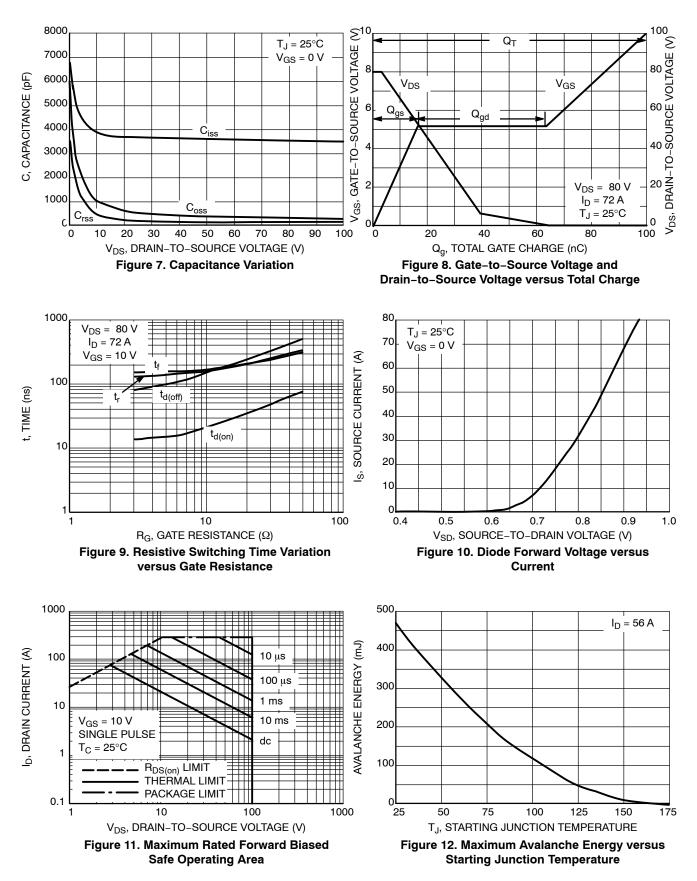
ORDERING INFORMATION

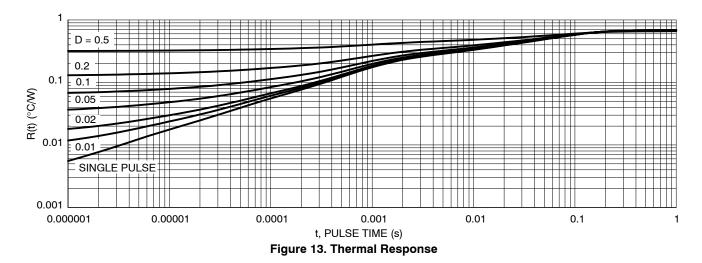
See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ Unless otherwise specified)

Characteristics	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V,	I _D = 250 μA	100			V
Drain-to-Source Breakdown Voltage Temper- ature Coefficient	V _{(BR)DSS} /T _J				113		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$			1.0	μA
		V _{DS} = 100 V	T _J = 125°C			100	1
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V	/ _{GS} = ±20 V			±100	nA
ON CHARACTERISTICS (Note 2)				-			-
Gate Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS},$	I _D = 250 μA	2.0		4.0	V
Negative Threshold Temperature Coefficient	V _{GS(th)} /T _J	<u> </u>			8.6		mV/°C
Drain-to-Source On-Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 72 A			12.7	14	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 5 V, I _D = 10 A			24		S
CHARGES, CAPACITANCES & GATE RESIST	ANCE				•		
Input Capacitance	C _{iss}				3700		pF
Output Capacitance	C _{oss}	V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz			550		
Reverse Transfer Capacitance	C _{rss}				200		
Total Gate Charge	Q _{G(TOT)}				100		nC
Threshold Gate Charge	Q _{G(TH)}				4.0		1
Gate-to-Source Charge	Q _{GS}	$V_{GS} = 10 \text{ V}, V_{DS} = 80 \text{ V},$ $I_D = 72 \text{ A}$			16		
Gate-to-Drain Charge	Q _{GD}				47		
Plateau Voltage	V _{GP}				5.2		V
Gate Resistance	R _G				3.1		Ω
SWITCHING CHARACTERISTICS, V _{GS} = 10 V	(Note 3)				•		
Turn-On Delay Time	t _{d(on)}	V_{GS} = 10 V, V_{DD} = 80 V, I _D = 72 A, R _G = 6.2 Ω			16		ns
Rise Time	t _r				144		
Turn–Off Delay Time	t _{d(off)}				107		
Fall Time	t _f				157		
DRAIN-SOURCE DIODE CHARACTERISTICS					•		
Forward Diode Voltage	V _{SD}	I _S = 72 A	$T_J = 25^{\circ}C$		0.92	1.3	V
			T _J = 125°C		0.86		1
Reverse Recovery Time	t _{rr}	V _{GS} = 0 V, I _S = 72 A, dI _S /dt = 100 A/μs			94		ns
Charge Time	t _a				64		
Discharge Time	t _b				30		1
Reverse Recovery Charge	Q _{RR}				330	1	nC







ORDERING INFORMATION

Device	Package	Shipping [†]
NTB6411ANG	D ² PAK (Pb-Free)	50 Units / Rail
NTB6411ANT4G	D ² PAK (Pb-Free)	800 / Tape & Reel
NTP6411ANG	TO-220 (Pb-Free)	50 Units / Rail
NVB6411ANT4G	D ² PAK (Pb-Free)	800 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

D²PAK 3 CASE 418B-04 **ISSUE K**

9.65

10.29

4.83

0.89

1.40

8.89

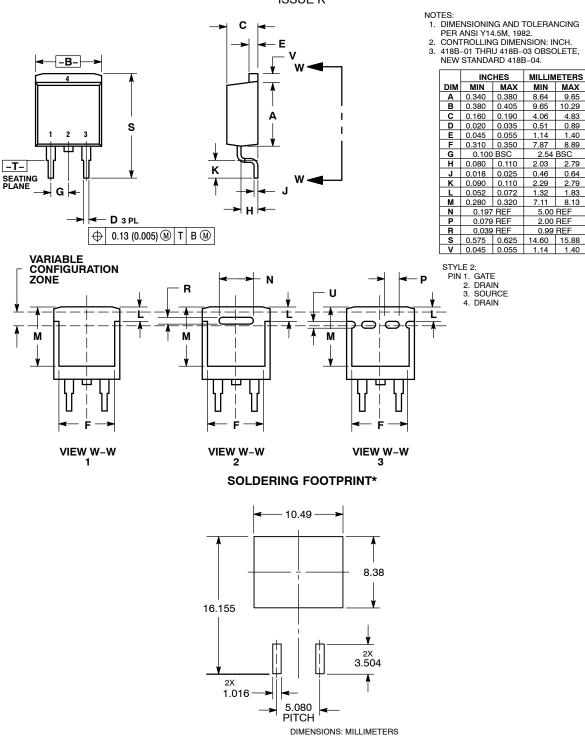
2.79

0.64

2.79

1.83

BSC

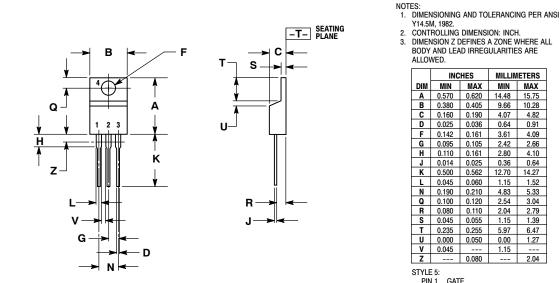


*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

> http://onsemi.com 6

PACKAGE DIMENSIONS





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MILLIMETERS

MIN MAX

15.75

4.82

0.91

4.09

2.66

4.10

0.64

14 27

1.52

5.33

3.04

1.39

6.47

1.27

2.04

14.48

9.66 10.28

4.07

0.64

3.61

2.42

2.80

0.36

1.15

4.83

2.54

2.04 2.79

1.15

5.97

1.15

DRAIN 2. 3. SOURCE 4. DRAIN

0.00

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